

MULTI-INNO TECHNOLOGY CO., LTD.

LCD MODULE SPECIFICATION

Model: MI240160E-G

Revision	0.0
Engineering	
Date	
Our Reference	



RECORDS OF REVISION

Date	Ver.	Description	Page	Design by
2008/03/19	0.0	NEW SAMPLE	-	



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Note: For detailed information please refer to IC data sheet: Controller --- ST7529-G





1. SPECIFICATIONS

1.1 Features

Standard Value
240 * 160 Dots
FSTN .POSITIVE, TRANSFLECTIVE .Extended Temp
LCD Module : 1/160 Duty, 1/12 Bias
6 O'clock
LED B/L
52g
-
Controller ST7529-G

1.2 Mechanical Specifications

z Wittenamical Specimenton	-~	
Item	Standard Value	Unit
Outline Dimension	83.8 (L) * 60.0 (w) * 7.0 (H)(Max)	mm
Viewing Area	69.6 (L) *47.6 (w)	mm
Active Area	67.425 (L) * 44.945 (w)	mm
Dot Size	0.266 (L) * 0.266 (w)	mm
Dot Pitch	0.281 (L) * 0.281 (w)	mm

Note: For detailed information please refer to LCM drawing

1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{DD}	_	-0.5	5.0	V
LCD Driver Supply Voltage	VLcd	_	-0.5	22.0	V
Input Voltage	V_{IN}	_	-0.5	V _{DD} +0.5	V
Operating Temperature	T _{OP}	_	-20	70	$^{\circ}$ C
Storage Temperature	T_{ST}	_	-30	80	$^{\circ}$
Storage Humidity	H_{D}	Ta < 60 ℃	-	90	%RH



1.4 DC Electrical Characteristics

 $V_{DD}\!\!=\!\!3.0\!\!\pm\!\!0.3V\!,\!V_{SS}\!=\!\!0V$, Ta = $25^{\circ}\!\!C$

	1		7 5.0 _ 0	.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,		
Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	$V_{ m DD}$	-	2.7	3.0	3.3	V
"H" Input Voltage	V _{IH}	-	0.7V _{DD}	-	V_{DD}	V
"L" Input Voltage	V_{IL}	-	V _{SS}	-	0.3V _{DD}	V
"H" Output Voltage	V_{OH}	-	-	-	-	V
"L" Output Voltage	$V_{ m OL}$	-	-	-	-	V
San also Constant	T	V _{DD} =3.0V, V _{OP} : 15.0V Pattern= Full display	-	0.29	-	
Supply Current	I_{DD}	V _{DD} =3.0V, V _{OP} : 15.0V Pattern= Horizontal line*1	-	0.30	1.0	mA
		-20°C	15.3	15.5	15.7	
LCM Driver Voltage	V _{OP} *2	25℃	14.8	15.0	15.2	V
		70℃	14.3	14.5	14.7	

NOTE: *1 The maximum current display

1.5 Optical Characteristics

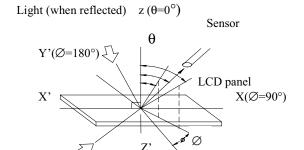
LCD Panel: 1/160Duty , 1/12ias , VLCD=15V,Ta =25°C

Item	Symbol	Conditions	Min.	Тур.	Max.	Reference
View Angle	θ	C≥2.0, Ø =0°	0°	35°	-	Notes 1 & 2
Contrast Ratio	С	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	6	-	Note 3
Response Time(rise)	tr	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	110ms	165ms	Note 4
Response Time(fall)	tf	$\theta = 5^{\circ}, \varnothing = 0^{\circ}$	-	280 ms	420 ms	Note 4

^{*2} The Vop test point is Vo-Vss



Note 1: Definition of angles θ and \emptyset

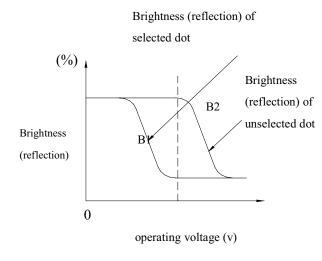


Light (when transmitted) $Y(\varnothing=0^{\circ})$ $(\theta=90^{\circ})$

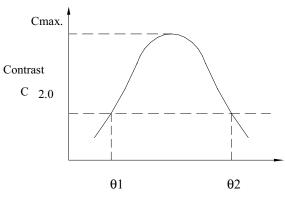
Note 3: Definition of contrast C

Brightness (reflection) of unselected dot (B2)

Brightness (reflection) of selected dot (B1)



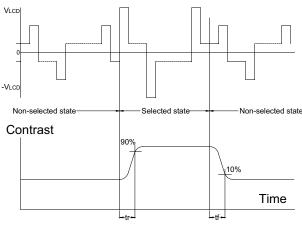
Note 2: Definition of viewing angles $\theta 1$ and $\theta 2$



viewing angle θ (Ø fixed)

Note: Optimum viewing angle with the naked eye and viewing angle θ at Cmax. Above are not always the same

Note 4: Definition of response time



Note: Measured with a transmissive LCD panel which is displayed 1 cm²

 V_{LCD} : Operating voltage f_{FRM} : Frame frequency t_r : Response time (rise) t_f : Response time (fall)



1.6 Backlight Characteristics

LCD Module with LED Backlight

Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°℃	-	120	mA
Reverse Voltage	VR	Ta =25°C	-	5	V
Power Dissipation	PO	Ta =25°C	-	288	MW

Electrical / Optical Characteristics

Ta =25°C

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	Vf	If=80 mA	-	3.2	-	V
Reverse Current	IR	VR=5V	-	-	0.2	mA
Average Brightness (with LCD)*1	IV	If=80mA	100	150		cd/m ²
CIE color coordinate	X	If=80mA	0.26	0. 29	0.32	nm
(with LCD)	Y	II-00IIIA	0.29	0.32	0.35	nm
Uniformity*2	ΔΒ	If=80mA	70	-	-	%
Color	White					

^{*1} This vaule will be changed while mass production

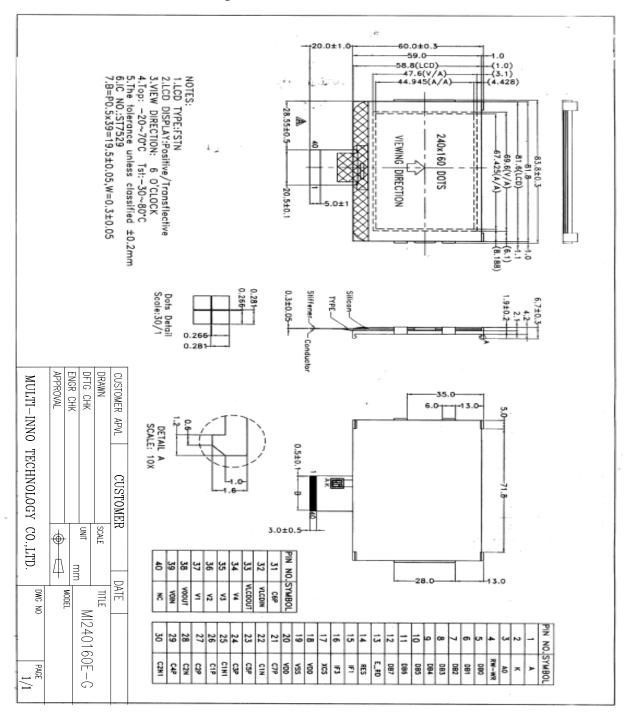
^{*2} $\Delta B=B(min)/B(max)$



2. MODULE STRUCTURE

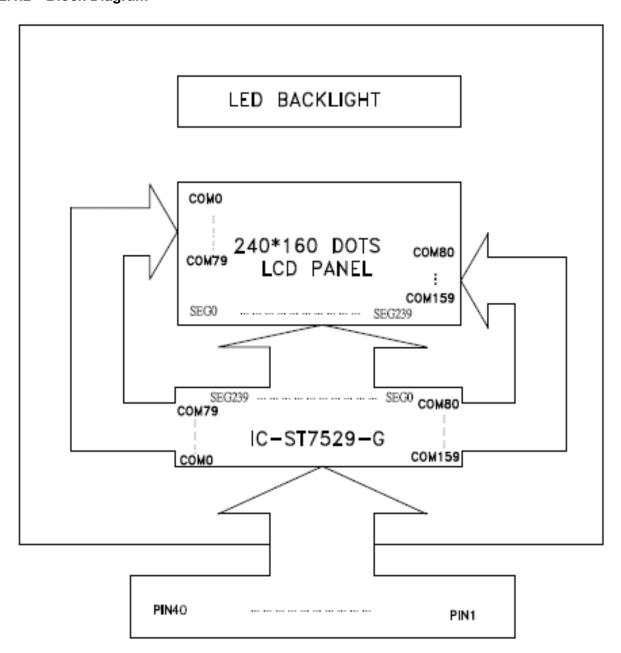
2.1 2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram





2.1.2 Block Diagram



Please refer interface pin description for detail



2.2Interface Pin Description

Pin No.	Symbol			Function			
1	A	Power supply for LED B/L.(Anode)					
2	K	Power supply	for LED	B/L (Cathode)			
		Register selec	Register select input pin				
3	A0			or SI are display data			
		1		or SI are control data			
		Read / Write ex					
		MPU type	RW_WR	Description			
4	RW-WR	6800-series	RW	Read / Write control input pin RW = "H" : read RW = "L" : write			
		8080-series	/WR	Write enable clock input pin The data on DB0 to DB15 are latched at the rising edge of the /WR signal.			
		They connect to the standard 8-bit MPU bus via the 8 bit					
				n the following interface is selected and the			
5~12	DB0~DB7	XCS pin is high, the following pins become impedance, which					
		should be fixed to VDD or VSS.					
		Read / Write execution control pin					
		MPU Type	E_RD	Description			
				Read / Write control input pin RW = "H": When E is "H", DB0 to DB15 are in an			
13	E_RD	6800-series	E	output status.			
				 RW = "L": The data on DB0 to DB15 are latched at the falling edge of the E signal. 			
		8080-series	/RD	Read enable clock input pin			
1.4	DEC		XX71	When /RD is "L", DB0 to DB15 are in an output status.			
14	RES	Reset input pi	n. When	RST is "L", initialization is executed.			
15	IF1	IF1	IF3	MPU interface type			
16	IF3	Н	L	80 series 8-bit parallel			
	11.0	L	Н	68 series 8-bit parallel			
		Chip select in	put pins				
17	XCS	Data/instruction I/O is enabled only when XCS is "L". When chip					
		select is non-active, DB0 to DB8 may be high impedance.					
18	VDD	Power supply (VDD=3.3V)					
19	VSS	Power supply (VSS=0)					
20	VDD	Power supply (VDD=3.3V)					
		DC/DC voltage	e converter	. Connect a capacitor between this terminal and			
21	C7P	1		•			
<u> </u>		the ≤7X VLCD; 8X C1N terminal.					



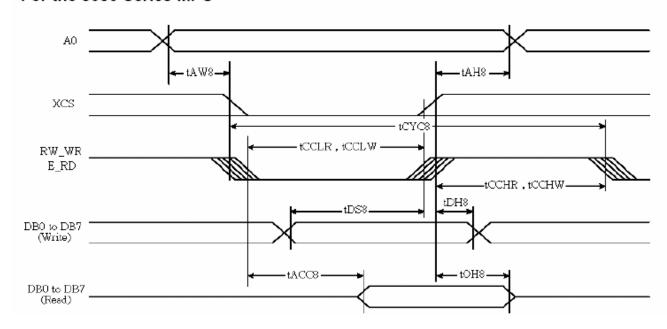
	1	1					
22	C1N	1	te converter. Converter. $Converter$. $Converter$. $Converter$.	-		is terminal and	
22	C5P	+				is terminal and	
23	CSP	the $\leq 5X \text{ VLC}$	$CD; \ge 6X C1N$	V terminal.			
24	C3P	DC/DC voltag	e converter. Co	nnect a capaci	tor between th	is terminal and	
	231	the $\leq 3X \text{ VLO}$	$CD; \ge 4X C1N$	V terminal.			
25	C1N1	DC/DC voltag	e converter. Co	onnect a capaci	tor between th	is terminal and	
	01111	the C1P termin	nal.				
26	C1P	DC/DC voltag	e converter. Co	onnect a capaci	tor between the	is terminal and	
	011	the C1N1 term	ninal.				
27	C2P	1		-	tor between th	is terminal and	
	<u></u>	the 2X VLCD	$\geq 3X$ C2N te	rminal.			
28	C2N	DC/DC voltag	e converter. Co	onnect a capaci	tor between th	is terminal and	
	0211	the $\leq 2X \text{ VLO}$	$CD; \ge 3X C2F$	terminal.			
29	C4P	DC/DC voltag	e converter. Co	onnect a capaci	tor between th	is terminal and	
2)	C-11	the ≤4X VL0	the $\leq 4X$ VLCD; $\geq 5X$ C2N terminal.				
30	C2N1	DC/DC voltage converter. Connect a capacitor between this terminal and					
	02111	the $\leq 6X$ VLCD; $\geq 7X$ C6P terminal.					
31	C6P	DC/DC voltage converter. Connect a capacitor between this terminal and				is terminal and	
31	Cor	the $\leq 6X$ VLCD; $\geq 7X$ C2N1 terminal.					
		An external Lo	CD supply volt	age can be sup	plied using the	VLCDIN pad.	
32	VLCDIN	In this case, V	LCDOUT has t	to be left open,	and the		
32	VECDIIV	Internal voltage generator has to be programmed to zero.(SET register					
		VB=0)	VB=0)				
		If the internal	voltage generat	tor is used, the	VLCDIN &	VLCDOUT	
33	VLCDOUT	must be conne	cted together.				
		If an external supply is used, this pin must be left open.					
34	V4	LCD driver sup	oply voltages				
35	V3		should be conn	-			
36	V2	_	ld have the follow	•	ship:		
37	V1	1	V2 ≥ V3 ≥ '		sea valtagae as	o congrated as	
38	V0OUT	When the internal power circuit is active, these voltages are generated as the following table according to the state of LCD bias.					
39	VOIN	LCD Bias	V1	V2	V3	V4	
39	VUIN	1/N Bias	1	(N-2) / N x V0	(2/N) x V0	(1/N) x V0	
		NOTE: N = 5 to 14					



40	NC	Not connection

Timing Characteristics

For the 8080 Series MPU



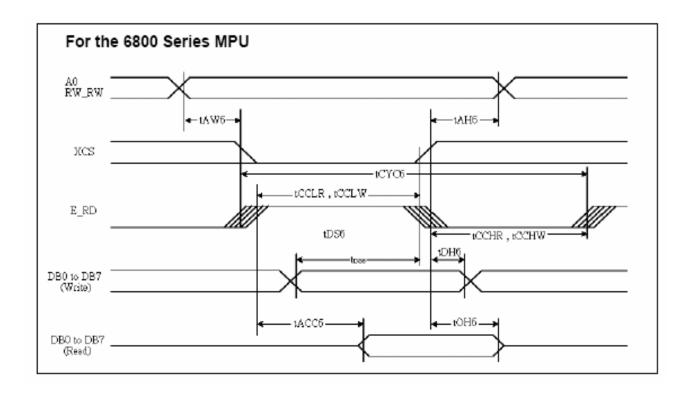
Rating Symbol Item Signal Condition Units Min Max 20 Address hold time t_{AH8} 20 Address setup time Α0 t_{AW8} System cycle time 200 t_{CYC8} Enable L pulse width (Write) 100 tcclw RW_WR Enable H pulse width (Write) 100 tcchw -Enable L pulse width (Read) 100 ns tcclr - E_RD Enable H pulse width (Read) 100 tcchr WRITE Data setup time 150 t_{DS8} _ -WRITE Address hold time 20 t_{DH8} -DB0 to DB7 READ access time 40 $C_L=100pF$ t_{ACC8} -READ Output disable time C_L=100pF

t_{OH8}

 $V_{DD} = 3.3V$, $Ta = 25^{\circ}C$

30

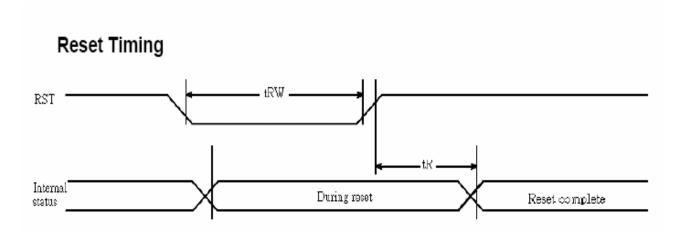




 $V_{DD} = 3.3V$, $Ta = 25^{\circ}C$

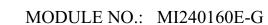
Item	Signal	Symbol	Condition	Rat	ing	Units
item	Signal	Symbol	Condition	Min	Max	UIIIS
Address hold time		t _{AH6}	-	20	-	
Address setup time	A0	t _{AW6}	-	20	-	
System cycle time	•	t _{CYC6}	-	200	1	
Enable L pulse width (Write)	מאין אום	t _{EWLW}	-	100	ı	
Enable H pulse width (Write)	RW_WR	t _{EWHW}	-	100	-	
Enable L pulse width (Read)	E RD	t _{EWLR}	-	100	-	ns
Enable H pulse width (Read)	L_ND	t _{EWHR}	-	100	-	
WRITE Data setup time		t _{DS6}	-	150	ı	
WRITE Address hold time	DD0 4- DD7	t _{DH6}	-	20	-	
READ access time	DB0 to DB7	t _{ACC6}	C _L =100pF	1	40	
READ Output disable time	·	t _{OH6}	C _L =100pF	-	30	





 V_{DD} = 3.3V , Ta = 25°C

Item	Signal	Symbol	Condition			Unite	
item	Signal	Syllibol	Condition	Min	Тур	Max	Units
Reset time	-	t _R		-	-	1	μs
Reset "L" pulse width	RES	t _{RW}	-	1	-	-	μs





2.4 Display Command

Ext=0 or Ext=1

Inde	Command	AO	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function
1	Ext In	0	1	0	0	0	1	1	0	0	0	0	Ext=0 Set
2	Ext Out	0	1	0	0	0	1	1	0	0	0	1	Ext=1 Set

Ext=0

Index	Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function
1	DISON	0	1	0	1	0	1	0	1	1	1	1	Display On
2	DISOFF	0	1	0	1	0	1	0	1	1	1	0	Display Off
3	DISNOR	0	1	0	1	0	1	0	0	1	1	0	Normal Display
4	DISINV	0	1	0	1	0	1	0	0	1	1	1	Inverse Display
5	COMSCN	0	1	0	1	0	1	1	1	0	1	τ-	COM Scan Direction
6	DISCTRL	0	1	0	1	1	0	0	1	0	1	0	Display Control
7	SLPIN	0	1	0	1	0	0	1	0	1	0	1	Sleep In
8	SLPOUT	0	1	0	1	0	0	1	0	1	0	0	Sleep Out
9	LASET	0	1	0	0	1	1	1	0	1	0	1	Line Address Set
10	CASET	0	1	0	0	0	0	1	0	1	0	1	Column Address Set
11	DATSDR	0	1	0	1	0	1	1	1	1	0	0	Data Scan Direction
12	RAMWR	0	1	0	0	1	0	1	1	1	0	0	Writing to Memory
13	RAMRD	0	1	0	0	1	0	1	1	1	0	1	Reading from Memory
14	PTLIN	0	1	0	1	0	1	0	1	0	0	0	Partial display in
15	PTLOUT	0	1	0	1	0	1	0	1	0	0	1	Partial display out
16	RMWIN	0	1	0	1	1	1	0	0	0	0	0	Read and Modify Write
17	RMWOUT	0	1	0	1	1	1	0	1	1	1	0	RMW end
18	ASCSET	0	1	0	1	0	1	0	1	0	1	0	Area Scroll Set
19	SCSTART	0	1	0	1	0	1	0	1	0	1	1	Scroll Start Set



20	OSCON	0	1	0	1	1	0	1	0	0	0	1	Internal OSC on
21	OSCOFF	0	1	0	1	1	0	1	0	0	1	0	Internal OSC off
22	PWRCTRL	0	1	0	0	0	1	0	0	0	0	0	Power Control
23	VOLCTRL	0	1	0	1	0	0	0	0	0	0	1	EC control
24	VOLUP	0	1	0	1	1	0	1	0	1	1	0	EC increase 1
25	VOLDOWN	0	1	0	1	1	0	1	0	1	1	1	EC decrease 1
26	RESERVED	0	1	0	1	0	0	0	0	0	1	0	Not Use
27	EPSRRD1	0	1	0	0	1	1	1	1	1	0	0	READ Register1
28	EPSRRD2	0	1	0	0	1	1	1	1	1	0	1	READ Register2
29	NOP	0	1	0	0	0	1	0	0	1	0	1	NOP Instruction
30	STREAD	0	0	1			F	Read	d Dat	ta			Status Read
31	EPINT	0	1	0	0	0	0	0	0	1	1	1	Initial code(1)

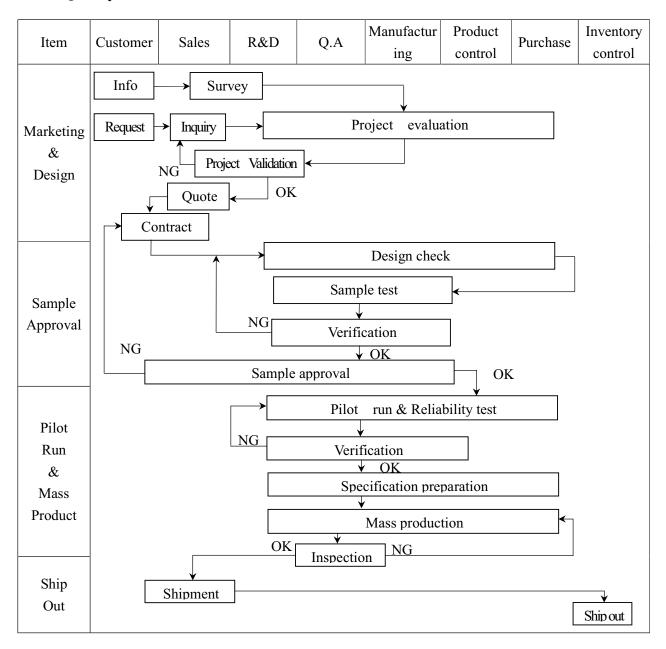
Ext=1

Index	Command	A0	RD	WR	D7	D6	D5	D4	D3	D2	D1	D0	Function
1	Gray 1 Set	0	1	0	0	0	1	0	0	0	0	0	FRAME 1 Gray PWM Set
2	Gray 2 Set	0	1	0	0	0	1	0	0	0	0	1	FRAME 2 Gray PWM Set
3	Wt. Set	0	1	0	0	0	1	0	0	0	1	0	Weight Set
4	ANASET	0	1	0	0	0	1	1	0	0	1	0	Analog Circuit Set
5	DITHOFF	0	1	0	0	0	1	1	0	1	0	0	Dithering Circuit Off
6	DITHON	0	1	0	0	0	1	1	0	1	0	1	Dithering Circuit On
7	EPCTIN	0	1	0	1	1	0	0	1	1	0	1	Control EEPROM
8	EPCOUT	0	1	0	1	1	0	0	1	1	0	0	Cancel EEPROM
9	EPMWR	0	1	0	1	1	1	1	1	1	0	0	Write to EEPROM
10	EPMRD	0	1	0	1	1	1	1	1	1	0	1	Read from EEPROM

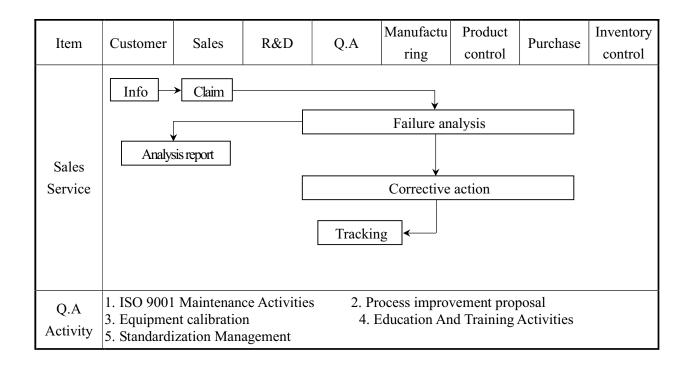


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart





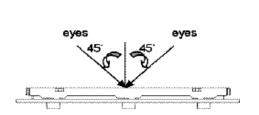


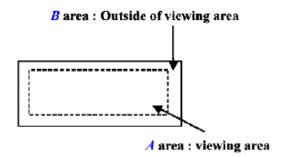




3.2 Inspection Specification

- ◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge \ MIL-STD \ Tester \ Sample
- ◆Defect Level: Major Defect AQL 0.4; Minor Defect AQL 1.5.
- ♦OUT Going Defect Level : Sampling .
- ◆Manner of appearance test :
 - (1). The test be under 40W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (3). Definition of area . (Fig. 2)





◆ Specification:

NO	Item	Criterion	level
01	Product condition	1.1 The part number is inconsistent with work order of Production. 1.2 Mixed production types.	Major Major
02	0	1.3 Assembled in inverse direction.	Major
02	Quantity	2.1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3.1 Product dimension and structure must conform to Structure diagram.	Major
		4.1 Missing line character \(\) dot and icon.	Major
		4.2 No function or no display.	Major
04	Electrical Testing	4.3 Output data is error.	Major
		4.4 LCD viewing angle defect.	Major
		4.5 Current consumption exceeds product specifications.	Major
	Black or white dot \ scratch \ \	5.1 Round type: 5.1.1 display only:	
05	contamination Round type	 • White and black spots on display ≤ 0.30mm, no more than Four white or black spots present. • Densely spaced : NO more than two spots or lines within 3mm 	Minor



◆Specification:

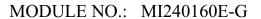
	ecification:	- C :						1 1
NO	Item	Criterion						level
05	Black or white dot \ scratch \ contamination Round type → x → Y	0. 0. 5.1.3 Line t Dimens Length L≤3.0mm	mension (diameter $\Phi \leq 0.10$ mm 10 mm $< \Phi \leq 0.20$ 20 mm $< \Phi \leq 0.30$ Total $\Phi = 0.30$	mm mm	2	se 3 2 4 eptan	ce (Q'ty) B area Don't count Don't count Don't count	Minor
	→ , ←	L ≤2.5mm	0.05 mm $< \Phi \le 0$					11
	L		w > 0.075m	m	As	roun	d type	
06	Polarizer Bubble	Φ ⊆ 0.20mm · 0.50mm · Φ ⊃ Tota	(diameter : Φ) $\leq 0.20 \text{mm}$ $< \Phi \leq 0.50 \text{mm}$ $< \Phi \leq 1.00 \text{mm}$ > 1.00 mm I quantity	Acc	Acceptance area ept no dense 3 2 0 4		Don't count Don't count Don't count Don't count Don't count Don't count	Minor
07	The crack of glass	_		Z Z	e terminal : $\frac{Y}{Y \le 1/2 D}$ Neglect	Z	$egin{array}{c} Z \ Z \leq t \end{array}$	Minor



	ecification:	Cuitanian				T1
NO	Item	Criterion	Crack:			Level
				and corner edge:	Z	
	The crack of glass		X	Y	Z	Minor
	X: The length of Crack		Neglect	Out A area	Neglect	
	Y: The width of crack	7.2.2	•			
07	Z: The thickness of crack		·	X		
	D: terminal length		X Neglect	Y Out A area	Z Neglect	
	T: The thickness of glass		regieet	Out 11 area	regieet	
	A: The length of glass	7.3 Glass	remain:			
					Y 1/3 d	Minor



NO	Item	Criterion			Level
07	The crack of glass X: The length of Crack Y: The width of crack Z: The thickness of crack D: terminal length T: The thickness of	7.4 Corner cr	ack and medial crack:	X SP	Minor
	glass	X	Y	Z	
	A: The length of	≤1/5a	Crack can't enter viewing area	≤ 1/2t	
	glass	≤1/5a	Crack can't exceed the half of width of SP width of SP	$1/2t < Z \le 2t$	
		8.1 Backlight	can't work normally.		Major
08	Backlight elements	8.2 Backlight	loesn't light or color is wrong.		Major
08	elements	8.3 Illuminatio	n source flickers when lit.		Major
		9.1 pin type m	ust match type in specification shee	et	Major
		9.2 No short ci	rcuits in components on PCB or F	PC	Major
09	General appearance	packaging	kaging must the same as specified specification sheet.		Major
		9.4 The folding acceptable	g and peeled off in polarizer are no	t	Major
			or FPC between B/L assembled depth as a second depth as a secon	istance	Major





4. RELIABILITY TEST

4.1 Reliability Test Condition

	Test Condition	T						
NO.	TEST ITEM	TEST CONDITION						
1	High Temperature Storage Test	Keep in 80 $\pm 2^{\circ}$ C 96 hrs						
		Surrounding temperature, then storage	ge at normal condition 4hrs					
2	Low Temperature Storage Test	Keep in -30 $\pm 2^{\circ}$ C 96 hrs						
		Surrounding temperature, then storage						
		Keep in $+60^{\circ}$ C/90%RH duration for						
		Surrounding temperature, then storage	ge at normal condition 4hrs					
3	High Humidity Storage	(Excluding the polarizer)Or	061					
	Tright frumdity Storage	Keep in +40°C/90%RH duration for						
		Surrounding temperature, then storage	1					
		Air Discharge:	Contact Discharge:					
		Apply 6 KV with 5 times	Apply 250V with 5 times					
		Discharge for each polarity +/-	discharge for each polarity +/-					
		1. Temperature ambient: 15° C \sim 35°	C					
		2. Humidity relative: 30%~60%						
4	ESD Test	3. Energy Storage Capacitance(Cs+Cd):150pF±10%						
		4. Discharge Resistance(Rd):330 Ω±10%						
		5. Discharge, mode of operation:						
		Single Discharge (time between successive discharges at least 1 s)						
		(Tolerance If the output voltage indication: ±5%)						
		$-20^{\circ}\text{C} \rightarrow 25^{\circ}\text{C} \rightarrow 70^{\circ}\text{C} \rightarrow 25^{\circ}\text{C}$						
5	Temperature Cycling Test	(30mins) (5mins) (30mins) (5mins)					
	Temperature Cycling Test	(30mins) (5mins) (5mins) (10 Cyc	ele					
		Surrounding temperature, then storage						
		1. Sine wave 10~55HZ frequency						
6	Vibration Test (Packaged)	2. The amplitude of vibration :1.5 n	` '					
		3. Each direction (XYZ) duration f						
		Packing Weight (Kg)						
			Drop Height (cm)					
		0 ~ 45.4	122					
		45.4 ~ 90.8	76					
7	Drop Test (Packaged)	90.8 ~ 454	61					
		Over 454	46					
		D 11 11 11 11 11 11 11 11 11 11 11 11 11						
		Drop direction: \%3 comer	/1 edges /6 sides etch 1times					
	J	I.						



5. PRECAUTION RELATING PRODUCT HANDLING 5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 350±20°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25° C $\pm 5^{\circ}$ C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required



6. PACKING Specification

No. 1 1 2 1 3 4 5 5 6 0	17112 1011002 0	LCM包装規札 LCM Packaging Spec al): (per carton) Model MI240160E-G BAG100100ARABA	ifications Dimensio	DATE 08/03/19	初版	版次Ve
1.包裝 No. 1 月 2 月 3 分 4 万 5 万 6 〇 7 分 8	麦材料規格表 (Packaging Materia Item 成品(1) LCM 静電袋 (2)BAG	al) : (per carton) Model MI240160E-G	Dimensio	08/03/19	19以成	
No. 1 1 1 2 1 3 4 5 5 5 6 6 7 8 8	Item 成品(1) LCM 靜電袋 (2)BAG	Model MI240160E-G				1 0.0
No. 1 1 1 2 1 3 4 5 5 5 6 6 7 8	Item 成品(1) LCM 靜電袋 (2)BAG	Model MI240160E-G				
1	成品(1) LCM 靜電袋 (2)BAG	MI240160E-G				Quantity
2 # 3 4 5 5 5 5 6 0 7 8 8	靜電袋 (2)BAG		83.8*60.0		— <u> </u>	432
3 3 4 5 5 5 6 6 7 8			100*100*		432	
4 5 5 5 6 0 7 3	ANGE CODITO	BAG290240BRBBA	240*290*		12	
5 5 6 6 7 3	刀卡A7(4)BX	BX29500010BZBA	295*105			78
6 G 7 3	刀卡B7(5)BX	BX24500010BZBA	245*105			24
7 3	C3内盒(6)Product Box	BX31025511AABA	310*255*			6
8	外紙箱(7)Carton	BX52532536CCBA	525*325			1
9			323 323			
	(1) LCM (1) LCM	and per oon 12 Alle	o. of boxes	6 =	432	
	(3)氣泡墊			1		
	(6)Product Box	(4)刀卡A? (5)刀卡B?				(7) Carton
		特 記 事 項(REM	(ARK)			
. Labo		IN HL FF CA (ACIV.	前		每一格放2) 對放入間格	